

## P-Channel Enhancement Mode Power MOSFET

<p><b>Description</b></p> <p>The G12P06K uses advanced trench technology to provide excellent <math>R_{DS(ON)}</math>, low gate charge. It can be used in a wide variety of applications.</p> <p><b>General Features</b></p> <ul style="list-style-type: none"> <li>● <math>V_{DS}</math> -60V</li> <li>● <math>I_D</math> (at <math>V_{GS} = -10V</math>) -12A</li> <li>● <math>R_{DS(ON)}</math> (at <math>V_{GS} = -10V</math>) &lt; 75mΩ</li> <li>● <math>R_{DS(ON)}</math> (at <math>V_{GS} = -4.5V</math>) &lt; 120mΩ</li> <li>● 100% Avalanche Tested</li> <li>● RoHS Compliant</li> </ul> <p><b>Application</b></p> <ul style="list-style-type: none"> <li>● Power switch</li> <li>● DC/DC converters</li> </ul>	<p>Schematic diagram</p> <p>TO-252</p>		
<b>Device</b>	<b>Package</b>	<b>Marking</b>	<b>Packaging</b>
G12P06K	TO-252	G12P06	2500pcs/Reel

<b>Absolute Maximum Ratings</b> $T_C = 25^\circ\text{C}$ , unless otherwise noted			
<b>Parameter</b>	<b>Symbol</b>	<b>Value</b>	<b>Unit</b>
Drain-Source Voltage	$V_{DS}$	-60	V
Continuous Drain Current	$I_D$	-12	A
Pulsed Drain Current (note1)	$I_{DM}$	-48	A
Gate-Source Voltage	$V_{GS}$	$\pm 20$	V
Single pulse avalanche energy (note3)	$E_{AS}$	60	mJ
Power Dissipation	$P_D$	27	W
Operating Junction and Storage Temperature Range	$T_J, T_{stg}$	-55 To 150	$^\circ\text{C}$
<b>Thermal Resistance</b>			
<b>Parameter</b>	<b>Symbol</b>	<b>Value</b>	<b>Unit</b>
Thermal Resistance, Junction-to-Case	$R_{thJC}$	4.68	$^\circ\text{C}/\text{W}$

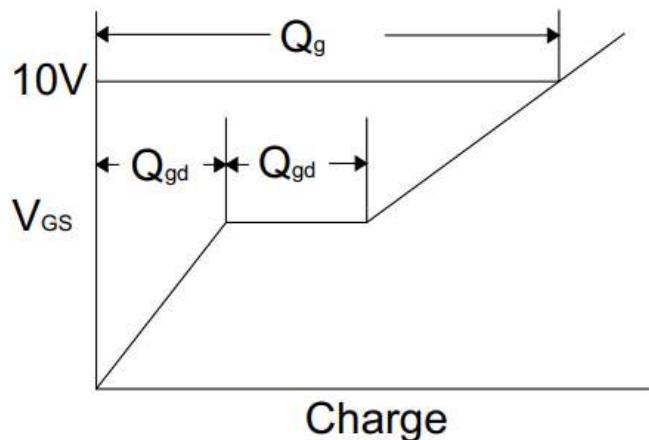
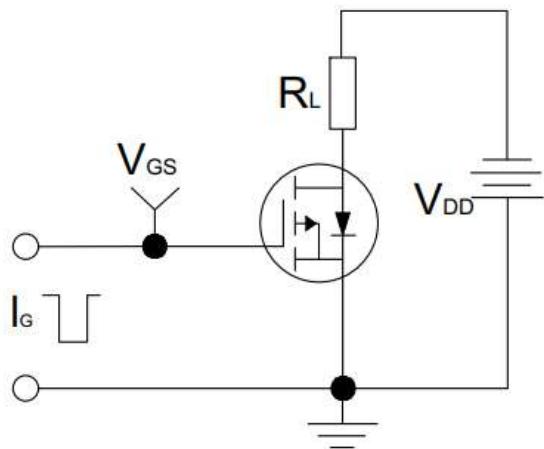
**Specifications**  $T_J = 25^\circ\text{C}$ , unless otherwise noted

Parameter	Symbol	Test Conditions	Value			Unit
			Min.	Typ.	Max.	
<b>Static Parameters</b>						
Drain-Source Breakdown Voltage	$V_{(\text{BR})\text{DSS}}$	$V_{\text{GS}} = 0\text{V}, I_D = -250\mu\text{A}$	-60	--	--	V
Zero Gate Voltage Drain Current	$I_{\text{DSS}}$	$V_{\text{DS}} = -60\text{V}, V_{\text{GS}} = 0\text{V}$	--	--	-1	$\mu\text{A}$
Gate-Source Leakage	$I_{\text{GSS}}$	$V_{\text{GS}} = \pm 20\text{V}$	--	--	$\pm 100$	$\text{nA}$
Gate-Source Threshold Voltage	$V_{\text{GS}(\text{th})}$	$V_{\text{DS}} = V_{\text{GS}}, I_D = -250\mu\text{A}$	-1.0	-1.5	-3	V
Drain-Source On-Resistance	$R_{\text{DS}(\text{on})}$	$V_{\text{GS}} = -10\text{V}, I_D = -6\text{A}$	--	56	75	$\text{m}\Omega$
		$V_{\text{GS}} = -4.5\text{V}, I_D = -5\text{A}$	--	68	120	
Forward Transconductance	$g_{\text{FS}}$	$V_{\text{DS}}=10\text{V}, I_D=-6\text{A}$	--	15	--	S
<b>Dynamic Parameters</b>						
Input Capacitance	$C_{\text{iss}}$	$V_{\text{GS}} = 0\text{V}, V_{\text{DS}} = -30\text{V}, f = 1.0\text{MHz}$	--	1108	--	$\text{pF}$
Output Capacitance	$C_{\text{oss}}$		--	74	--	
Reverse Transfer Capacitance	$C_{\text{rss}}$		--	58	--	
Total Gate Charge	$Q_g$	$V_{\text{DD}} = -30\text{V}, I_D = -6\text{A}, V_{\text{GS}} = -10\text{V}$	--	23	--	$\text{nC}$
Gate-Source Charge	$Q_{\text{gs}}$		--	4	--	
Gate-Drain Charge	$Q_{\text{gd}}$		--	5	--	
Turn-on Delay Time	$t_{\text{d}(\text{on})}$	$V_{\text{DD}} = -30\text{V}, I_D = -6\text{A}, R_G = 3\Omega$	--	8	--	$\text{ns}$
Turn-on Rise Time	$t_r$		--	4	--	
Turn-off Delay Time	$t_{\text{d}(\text{off})}$		--	32	--	
Turn-off Fall Time	$t_f$		--	7	--	
<b>Drain-Source Body Diode Characteristics</b>						
Continuous Body Diode Current	$I_S$	$T_C = 25^\circ\text{C}$	--	--	-12	A
Body Diode Voltage	$V_{\text{SD}}$	$T_J = 25^\circ\text{C}, I_{\text{SD}} = -6\text{A}, V_{\text{GS}} = 0\text{V}$	--	--	-1.2	V
Reverse Recovery Time	$T_{\text{rr}}$	$I_S = -8\text{A}, V_{\text{GS}} = 0\text{V}$ $dI/dt = -100\text{A/us}$	--	25	--	ns
Reverse Recovery Charge	Qrr		--	31	--	nc

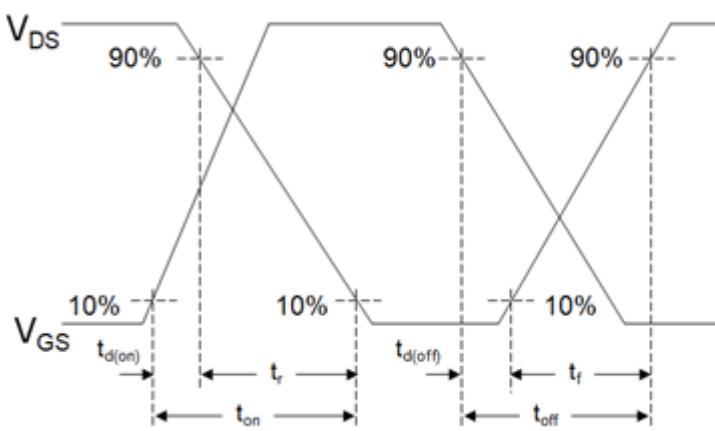
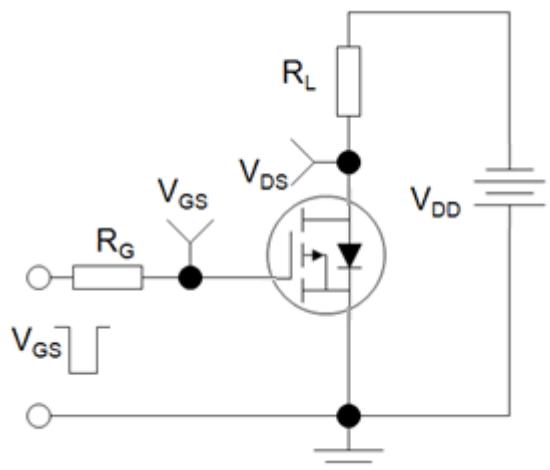
**Notes**

1. Repetitive Rating: Pulse width limited by maximum junction temperature
2. Identical low side and high side switch with identical  $R_G$
3. EAS condition :  $T_J=25^\circ\text{C}$ ,  $V_{\text{DD}}=-50\text{V}$ ,  $V_{\text{GS}}=-10\text{V}$ ,  $L=0.5\text{mH}$ ,  $R_g=25\Omega$

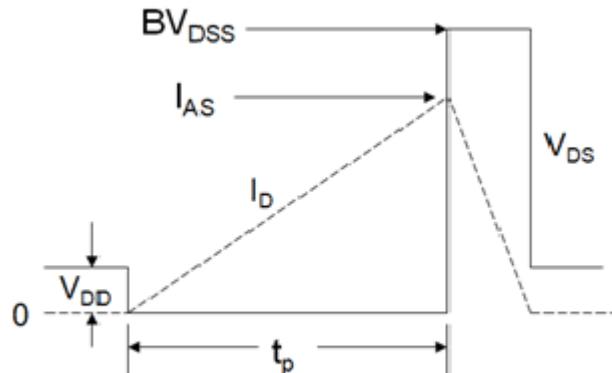
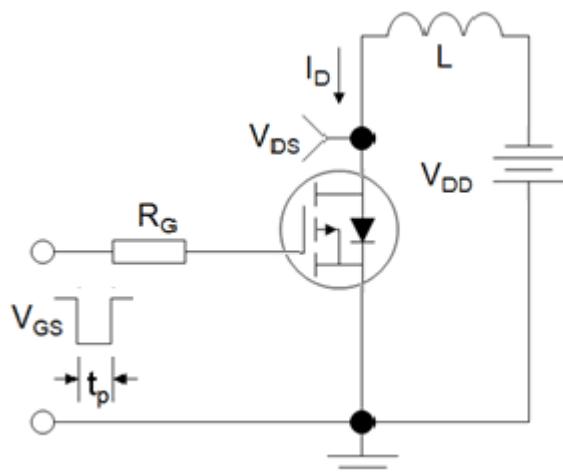
Gate Charge Test Circuit



Switch Time Test Circuit

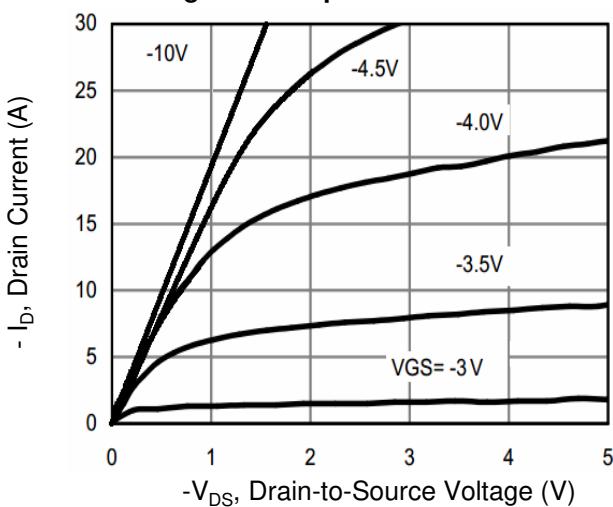


EAS Test Circuit

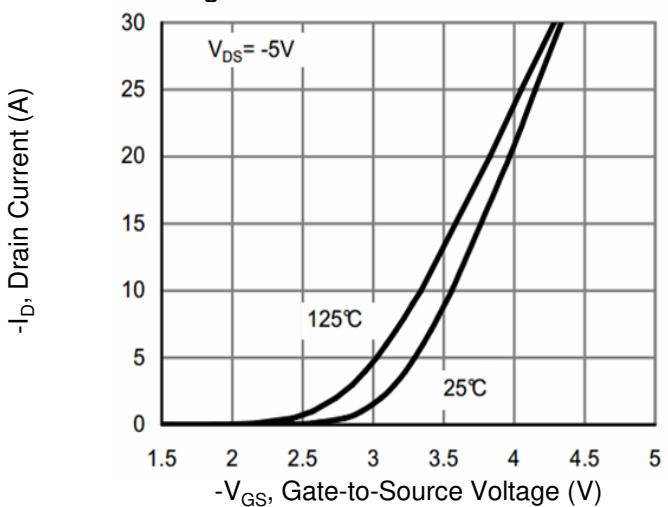


**Typical Characteristics**  $T_J = 25^\circ\text{C}$ , unless otherwise noted

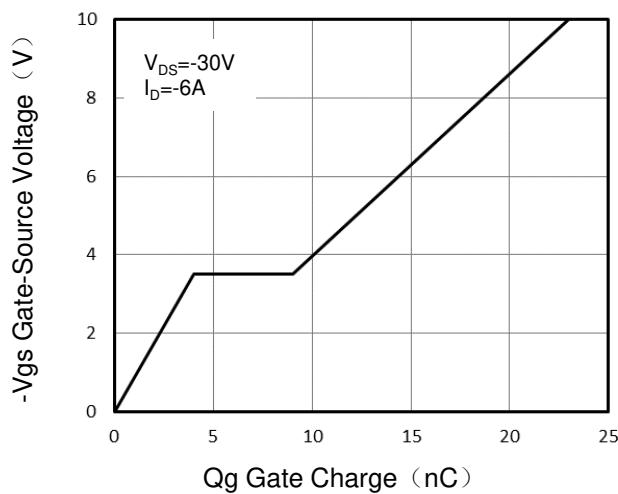
**Figure 1. Output Characteristics**



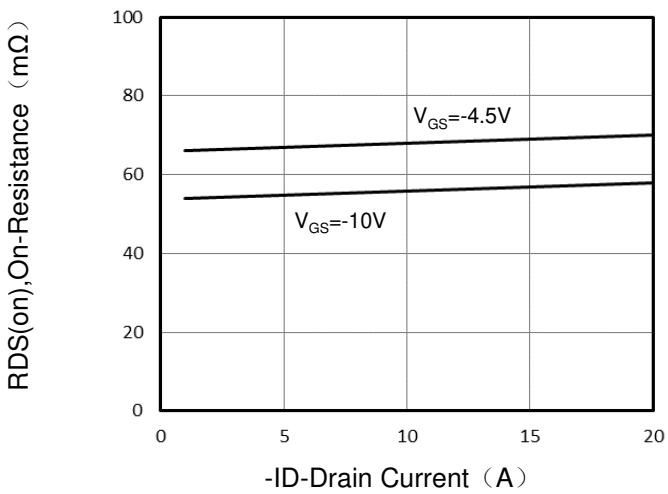
**Figure 2. Transfer Characteristics**



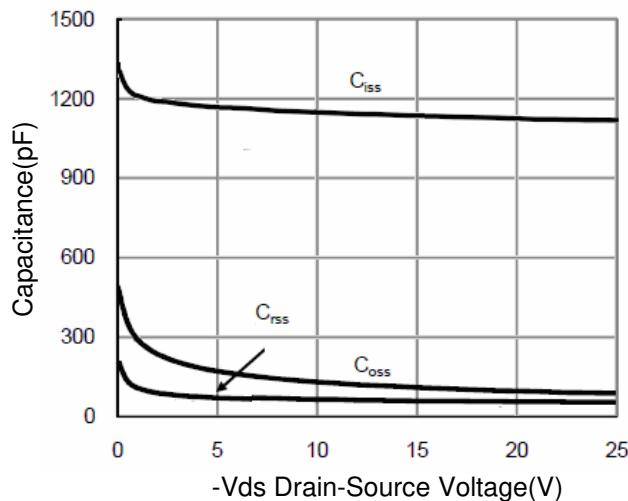
**Figure 3. Gate Charge**



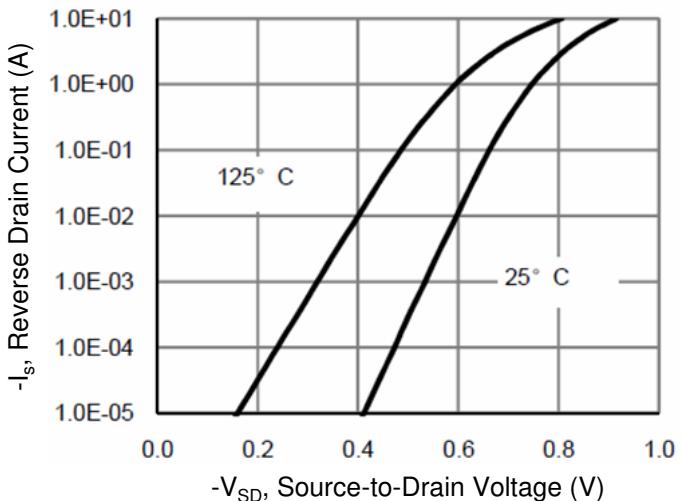
**Figure 4. Drain Source On Resistance**



**Figure 5. Capacitance**

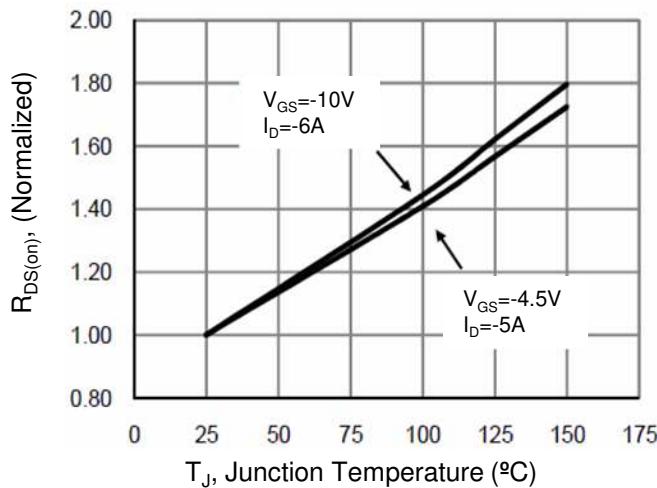


**Figure 6. Source-Drain Diode Forward**

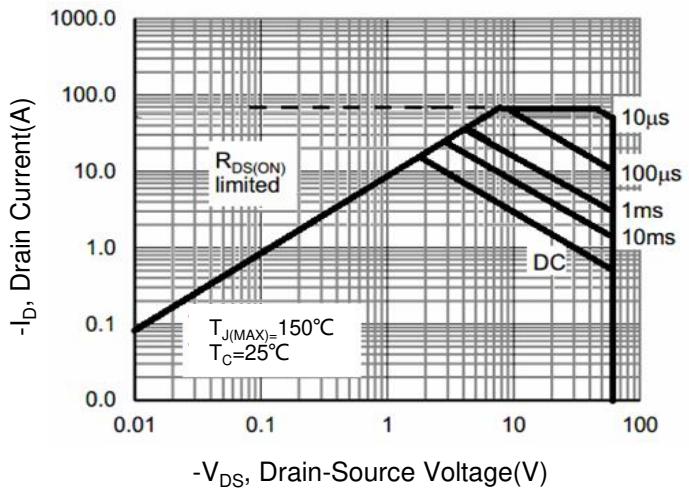


**Typical Characteristics**  $T_J = 25^\circ\text{C}$ , unless otherwise noted

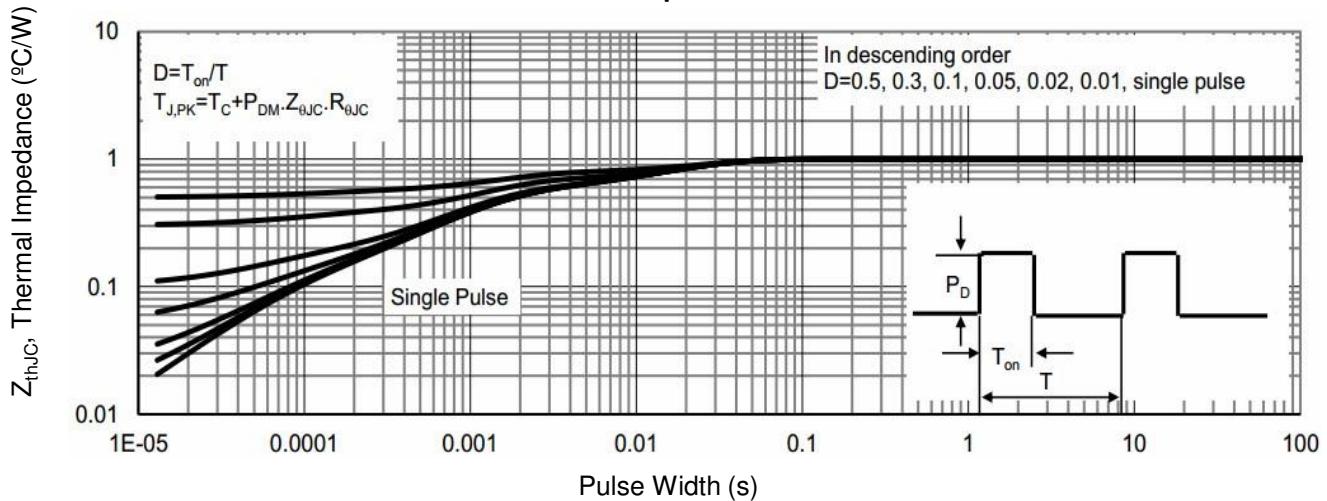
**Figure 7. Drain-Source On-Resistance**



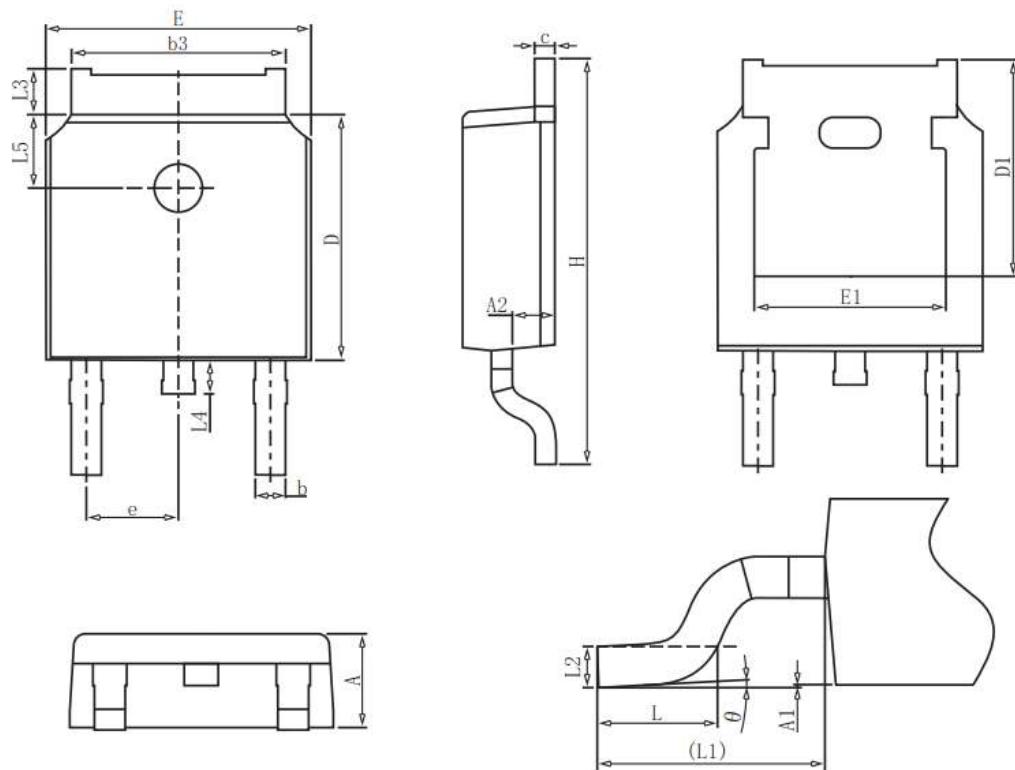
**Figure 8. Safe Operation Area**



**Figure 9. Normalized Maximum Transient Thermal Impedance**



## TO-252 Package Information



Symbol	Dimensions in Millimeters		
	MIN.	NOM.	MAX.
A	2.2	2.3	2.4
A1	0		0.2
A2	0.97	1.07	1.17
b	0.68	0.78	0.9
b3	5.2	5.33	5.5
c	0.43	0.53	0.63
D	5.98	6.1	6.22
D1	5.30REF		
E	6.4	6.6	6.8
E1	4.63		
e	2.286BSC		
H	9.4	10.1	10.5
L	1.38	1.5	1.75
L1	2.90REF		
L2	0.51BSC		
L3	0.88		1.28
L4	0.5		1
L5	1.65	1.8	1.95
θ	0°		8°